# **UNR7231** (UN7231)

### Silicon NPN epitaxial planar type

For low-frequency amplification

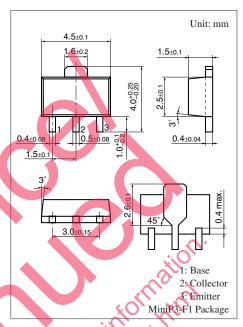
#### ■ Features

- High forward current transfer ratio h<sub>FE</sub>
- Costs can be reduced through downsizing of the equipment and reduction of the number of parts.

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	20	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	
Collector current	$I_{C}$	0.7	A	
Peak collector current	$I_{CP}$	1.5	A	
Total power dissipation *	P <sub>T</sub>	1.0	W	
Junction temperature	T <sub>j</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion



Marking Symbol: 10

#### Internal Connection

$$\begin{array}{c|c} R_1(1 \text{ k}\Omega) \\ \text{Bo-W} \\ R_2 \\ \text{(47 k}\Omega) \end{array} \sim C$$

#### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

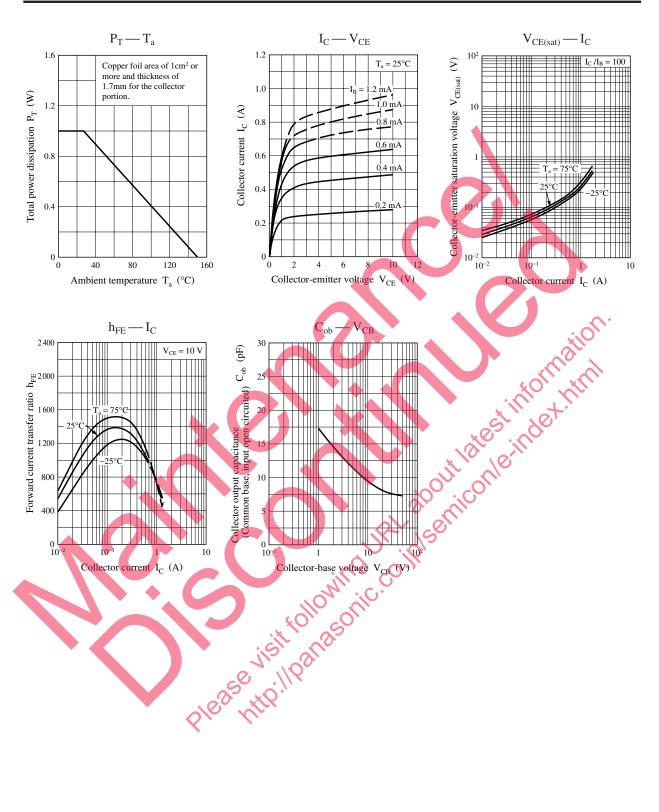
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \mu\text{A}, I_E = 0$	20			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 15 \text{ V}, I_E = 0$			1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 15 \text{ V}, I_{B} = 0$			10	μΑ
Emitter-base cutoff current (Collector open)	IEBO	$V_{EB} = 14 \text{ V}, I_C = 0$			0.5	mA
Forward current transfer ratio *	hpp	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	800		2 100	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 500 \text{ mA}, I_B = 5 \text{ mA}$			0.4	V
Input resistance	$R_1$		0.7	1.0	1.3	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.016	0.021	0.025	_
Transition frequency	$f_T$	$V_{CB} = 20 \text{ V}, I_E = -20 \text{ mA}, f = 200 \text{ MHz}$		55		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Pulse measurement

Note) The part number in the parenthesis shows conventional part number.

UNR7231 Panasonic



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